# Minstar Display Co., LTD





住址: 407 台中市中清路 163 號 No.163 Chung Ching RD., Taichune, Taiwan, R.O.C

WEB: <a href="http://www.winstar.com.tw">http://www.winstar.com.tw</a>
E-mail: winstar@winstar.com.tw
Tel:886-4-24262208 Fax: 886-4-24262207

### **SPECIFICATION**

CUS'	<b>LOW</b> 1	ER:				
MODULE NO.:		7	WF43BTIBE	<b>EDO</b> #		
APPI	ROVE	ED BY	<b>7</b> •			
( FOR CUS	STOMER	USE ON	LY)	PCB V	ERSION:	DATA:
SALES	BY	APPRO	OVED	ВҮ	CHECKED BY	PREPARED BY
	Γ					
VERSION	DA	ATE		/ISED E NO.		
0	2009.	.08.12			First issue	



MODLE NO:

VERSION DATE REVISED PAGE NO. SUMMARY  0 2009.08.12 First issue	RECORDS OF REVISION				DOC. FIRST ISSUE
0 2009.08.12 First issue	VERSION	DATE	REVISED PAGE NO.	SUI	MMARY
	0	2009.08.12		Fin	rst issue

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### 1. Module Classification Information

- ① Brand: WINSTAR DISPLAY CORPORATION
- ② Display Type: H→Character Type, G→Graphic Type F→TFT Type
- 3 Display Size: 4.3" TFT
- Model serials no.
- $\ \$  Backlight Type : F $\rightarrow$ CCFL, White  $T\rightarrow$ LED, White
- © LCD Polarize
  Type/ Temperature
  range/ View
  direction

  A→Reflective, N.T, 6:00
  D→Reflective, N.T, 12:00
  G→Reflective, W. T, 6:00
  Type/ Temperature
  range/ View
  direction

  B→Reflective, W. T, 6:00
  Type/ Temperature
  Type/ T
- ② A: TFT LCD
  - B: TFT+FR+CONTROL BOARD
  - C: TFT+FR+A/D BOARD
  - D:TFT+FR+A/D BOARD+CONTROL BOARD
- Solution: A: 128160 B:320234 C:320240 D:480234 E: 480272
- D: Digital A: Analog
- (10) Version
- ① Special Code #:Fit in with ROHS directive regulations

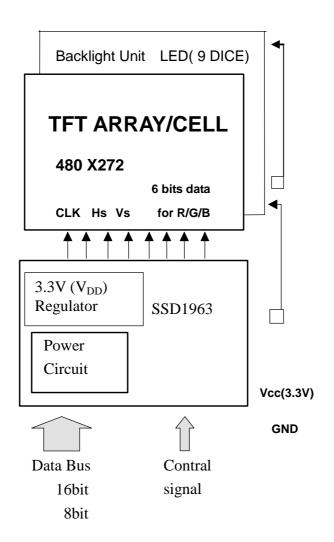
This product is composed of a TFT LCD panel, driver ICs, FPC, Control Board and a backlight unit. The following table described the features of WF43BTIBED0#

Item	Dimension	Unit
Dot Matrix	480 x RGBx 272(TFT)	dots
Module dimension	105.5x 67.2 x 4.7 (max)	mm
View area	95.04x 53.856	mm
Dot pitch	0.198 x 0.198	mm
Driving IC package	COG	
LCD type	TFT, Negative, Transmissive	-
View direction	6 o'clock	
Backlight Type	LED,Normally White	
Controller IC	SSD1963	

<sup>\*</sup>Expose the IC number blaze (Luminosity over than 1 cd) when using the LCM may cause IC operating failure.

<sup>\*</sup>Color tone slight changed by temperature and driving voltage.

### 2. Block Diagram



# 3.Electrical Characteristics

			Values			
Item	Symbol	Min	TYP	max	Unit	Remark
Operating voltage	VDD	3.0	3.3	3.6	V	
Input high voltage	VIH	0.8*VDD	-	VDD	V	
Input low voltage	VIL	0	-	0.2*VDD	V	
Output high voltage	VOH	VDD-0.3		VDD	V	
Output low voltage	VOL	0	-	0.3	V	
Current Consumption	IVCI	-	285	-	mA	
Power Consumption	PLCD	-	940.5	-	mW	

# 4. Absolute Maximum Ratings

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	$T_{\mathrm{OP}}$	-20	_	+70	$^{\circ}\! \mathbb{C}$
Storage Temperature	$T_{ST}$	-30	_	+80	$^{\circ}\!\mathbb{C}$
Power Supply Voltage	VGH-VGL	-0.3		+45	Vss=0
	VCC	-0.3	_	6.0	V

# 5.Interface Pin Function

#### 5-1 Pins Connection To Control Board

P/N	Symbol	8 B IT Function
1	GND	Ground
2	VCC	Power supply for Logic
3	B\L Enable	Backlight control
4	RS	Command/Data select
5	WR	8080 family MPU interface: Write signal
6	RD	8080 family MPU interface: Read signal
7	DB0	Data bus
8	DB1	
9	DB2	
10	DB3	
11	DB4	
12	DB5	
13	DB6	
14	DB7	
15	CS	Chip select
16	RES	REST
17	NC	No connection
18	NC	No connection
19	DISP ON	Display on
20	NC	No connection

# 6. DC CHARATERISTICS

#### **Conditions:**

Voltage referenced to VSS VDDD, VDDPLL = 1.2V VDDIO, VDDLCD = 3.3V TA = 25°C

#### **DC** Characteristics

Symbol	Parameter	<b>Test Condition</b>	Min	Тур	Max	Unit
PSTY	Quiescent Power			300		uW
IIZ	Input leakage current		-1		1	uA
IOZ	Output leakage current		-1		1	uA
VOH	Output high voltage		0.8VDDIO			V
VOL	Output low voltage				0.2VDDIO	V
VIH	Input high voltage		0.8VDDIO		VDDIO + 0.5	V
VIL	Input low voltage				0.2VDDIO	V

### 7. AC Characteristics

#### **Conditions:**

Voltage referenced to Vss

 $V_{\rm DDD}$ ,  $V_{\rm DDPLL} = 1.2V$ 

 $V_{DDIO}$ ,  $V_{DDLCD} = 3.3V$ 

 $T_A = 25$ °C

CL = 50pF (Bus/CPU Interface)

CL = 0pF (LCD Panel Interface)

#### 7.1 Clock Timing

#### **Clock Input Requirements for CLK (PLL-bypass)**

Symbol	Parameter	Min	Max	Units
FCLK	Input Clock Frequency (CLK)		120	MHz
TCLK	Input Clock period (CLK)	1/fCLK		ns

#### **Clock Input Requirements for CLK (Using PLL)**

Symbol	Parameter	Min	Max	Units
FCLK	Input Clock Frequency (CLK)	2.5	50	MHz
TCLK	Input Clock period (CLK)	1/fCLK		ns

#### **Clock Input Requirements for crystal oscillator XTAL (Using PLL)**

Symbol	Parameter	Min	Max	Units
FXTAL	Input Clock Frequency	2.5	10	MHz
TXTAL	Input Clock period	1/fXTAL		ns

### 7.2 MCU Interface Timing

#### 7.2.1 6800 Mode

Table 7-4: 6800 Mode Timing

Symbol	Parameter	Min	Тур	Max	Unit
tcyc	Reference Clock Cycle Time	9	1	-	ns
tPWCSL	Pulse width CS# or E low	1	1	-	tCYC
tPWCSH	Pulse width CS# or E high	1	ı	-	tCYC
tFDRD	First Data Read Delay	5	1	-	tCYC
tAS	Address Setup Time	1	1	_	ns
tAH	Address Hold Time	1	1	_	ns
tDSW	Data Setup Time	4	1	_	ns
tDHW	Data Hold Time	1	1	-	ns
tDSR	Data Access Time	ı	1	5	ns
tDHR	Output Hold time	1	1	_	ns

Figure 7-1: 6800 Mode Timing Diagram (Use CS# as Clock)

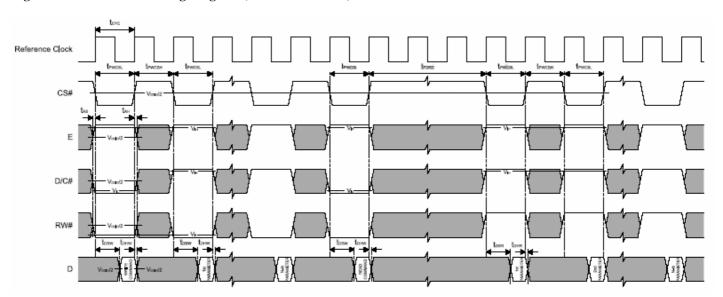
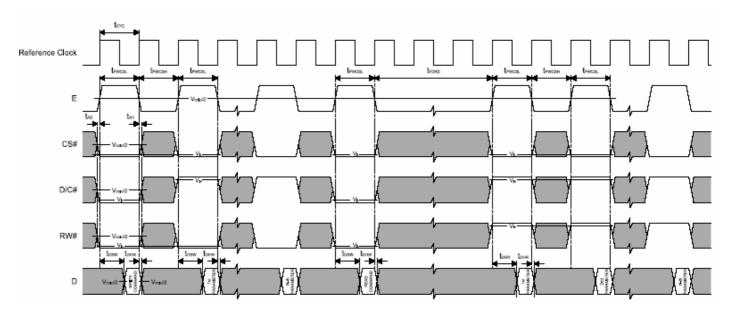


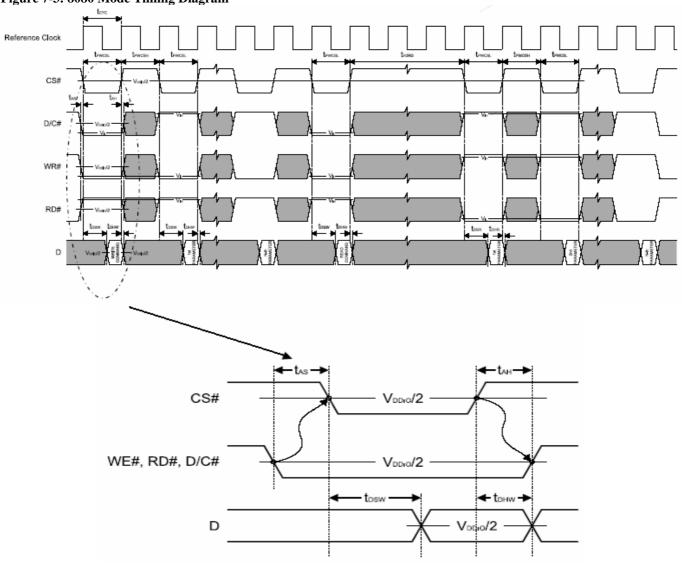
Figure 7-2: 6800 Mode Timing Diagram (Use E as Clock)



# 7.2.2 8080 Mode Write Cycle Table 7-5: 8080 Mode Timing

Symbol	Parameter	Min	Тур	Max	Unit
tcyc	Reference Clock Cycle Time	9	-	-	ns
tPWCSL	Pulse width CS# low	1	-	-	tCYC
tPWCSH	Pulse width CS# high	1	-	-	tCYC
tFDRD	First Read Data Delay	5	-	-	tCYC
tAS	Address Setup Time	1	-	-	ns
tAH	Address Hold Time	1	-	-	ns
tDSW	Data Setup Time	4	-	-	ns
tDHW	Data Hold Time	1	-	-	ns
tDSR	Data Access Time	-	-	5	ns
tDHR	Output Hold time	1	-	-	ns

Figure 7-3: 8080 Mode Timing Diagram



# 8. Data transfer order Setting

#### **Pixel Data Format**

Both 6800 and 8080 support 8-bit, 9-bit, 16-bit, 18-bit and 24-bit data bus. Depending on the width of the data bus, the display data are packed into the data bus in different ways.

#### Pixel Data Format:

Interface	Cycle	D[23]	D[22]	D[21]	D[20]	D[19]	D[18]	D[17]	D[16]	D[15]	D[14]	D[13]	D[12]	D[11]	D[10]	D[9]	D[8]	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]
24 bits	15	R7	R6	R5	R4	R3	R2	R1	R0	G7	G6	G5	G4	G3	G2	G1	G0	B7	B6	B5	B4	В3	B2	B1	В0
18 bits	15							R5	R4	R3	R2	R1	R0	G5	G4	G3	G2	G1	G0	B5	B4	В3	B2	B1	В0
16 bits (565 format)	15									R5	R4	R3	R2	R1	G5	G4	G3	G2	G1	GD	B5	B4	В3	B2	B1
	15									R5	R4	R3	R2	R1	R0	Х	Х	G5	G4	G3	G2	G1	GD	Х	Х
16 bits	2 <sup>rd</sup>									B5	B4	В3	B2	B1	B0	Х	Х	R5	R4	R3	R2	R1	RD	Х	Х
	319									G5	ď	G3	G2	G1	GD	х	Х	B5	B4	В3	B2	B1	B0	х	Х
9 bits	15																R5	R4	R3	R2	R1	RD	G5	G4	G3
	2 <sup>rd</sup>																G2	G1	G0	B5	B4	В3	B2	B1	В0
	15																	R5	R4	R3	R2	R1	RD	Х	Х
8 bits	2 <sup>rd</sup>																	G5	G4	G3	G2	G1	GD	Х	Х
	34																	B5	B4	В3	B2	B1	B0	Х	Х

X: Don't Care

# 9 Register Depiction

Please consult the spec of SSD1963

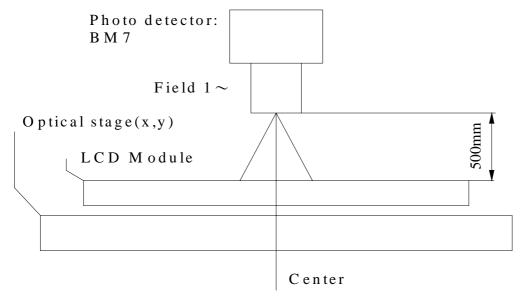
### **10. OPTICAL CHARATERISTIC**

The following items are measured under stable conditions. The optical characteristics should be measured in a dark room or equivalent with the methods shown in Note.1.

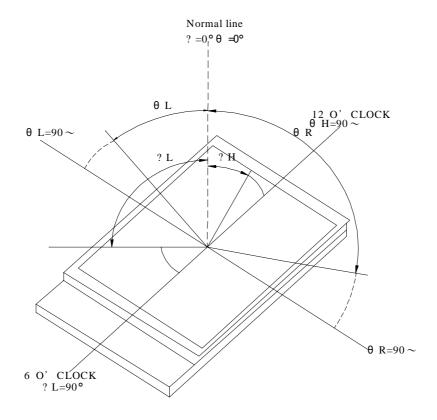
7.1 Main LCD Optical Characteristics

	Item Sym			Condition	Min	TYP	max	Unit	Remark
		Top	FH		-	50	-		
Viewing	Botte	om	FL	FL CR ≥ 10		55	-	degree	Note.2
Angle	Left		TL	CR > 10	-	60	-	uegree	Note.2
	Righ	nt	TR		-	60			
Response	tin	ne (Tr+T	f)	T=0		50	-	ms	Note.3
Brightnes	Brightness			Center	350	400		Cm/m <sup>2</sup>	
Cont	Contrast Ratio CR		CR	At optimized Viewing angle	200	250	-	-	Note.4
	White		Xw		0.258	0.308	0.358	-	Note.5
			Yw		0.278	0.328	0.378		
		Red	XR	Viouina normal	0.558	0.608	0.658	-	
Color		Red	YR	Viewing normal angle F,T=0	0.307	0.357	0.407		
chromatic	city	Green	XG	angle 1,1=0	0.279	0.329	0.379	-	_
		Giccii	YG		0.533	0.583	0.633		_
	Blue		XB		0.093	0.143	0.193	-	_
		Diuc	YB		0.050	0.100	0.150		

Note.1: After stabilizing and leaving the panel alone at a given temperature for 30 minutes, the measurement should be executed. Measurement should be executed in a stable, windless, and dark room .Optical specifications are measures by Topcon BM-7(fast) With a viewing angle of 1° at a distance of 50 cm and normal direction.

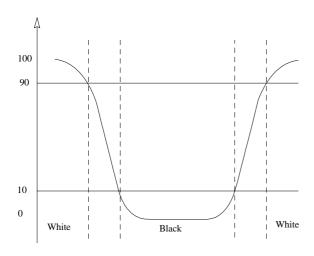


Not.2:Definition of Viewing Angle: Refer to figure as below:



Not.3:Definition of Response Time: TR and TF

The figure below is the output signal of the photo detector.



Not4:Definition of Contrast Ratio(CR)

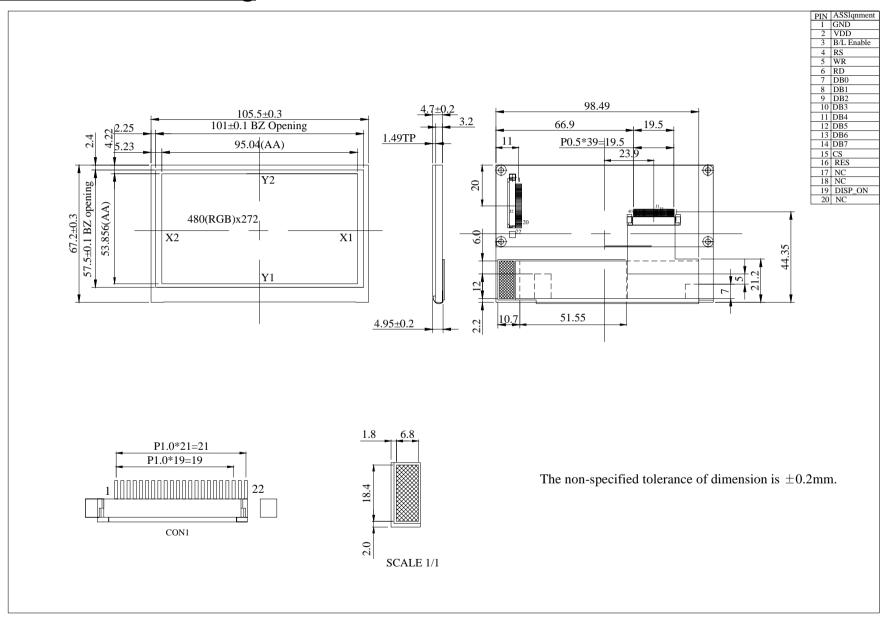
Ratio of gray max (G max)&gray min(G min)

(G max)=luminance with all pixel white

(G min)= luminance with all pixel black

Not5:Measured at the center area of the panel when all the input terminals of LCD panel are electrically opened.

### 11.Contour Drawing



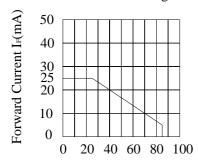
## 12. LED driving conditions

#### Backlight Unit(VSS=0v)

			Values				
Item	Symbol	ool Min		max	Unit	Remark	
LED Voltage	VL	-	25	-	V		
LED Current	IF	-	20	-	MA		
Power Consumption	PLED	-	500	-	MW		

#### **LED Forward Current**

Forward Current Derating Curve



Ambient Temperatur Ta(∼C)

# 13. <u>Inspection specification</u>

NO	Item	Criterion						
01	Electrical Testing	<ol> <li>1.1 Missing vertical, horizontal segment, segment contrast defect.</li> <li>1.2 Missing character, dot or icon.</li> <li>1.3 Display malfunction.</li> <li>1.4 No function or no display.</li> <li>1.5 Current consumption exceeds product specifications.</li> <li>1.6 LCD viewing angle defect.</li> <li>1.7 Mixed product types.</li> <li>1.8 Contrast defect.</li> </ol>						
02	Black or white spots on LCD (display only)	<ul> <li>2.1 White and black spots on display ≤0.25mm, no more than three white or black spots present.</li> <li>2.2 Densely spaced: No more than two spots or lines within 3mm</li> </ul>						
03	LCD black spots, white spots, contamination	3.1 Round type: As following $\Phi = (x + y) / 2$ $\longrightarrow X$ $\uparrow$ $\uparrow$ $\uparrow$ $\uparrow$	SIZE $\Phi \le 0.10$ $0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$ $0.25 < \Phi$		2.5			
	(non-display)  3.2 Line type:	L≦2.5	$\begin{array}{c} \text{g drawing)} \\ \hline \text{Width} \\ \hline \text{W} \leq 0.02 \\ 0.02 < \text{W} \leq 0.03 \\ 0.03 < \text{W} \leq 0.05 \\ 0.05 < \text{W} \end{array}$	Acceptable Q TY Accept no dense  2 As round type	2.5			
04	Polarizer bubbles	to find, must check in specify direction.	Size Φ $ Φ \le 0.20 $ 0.20 $Φ \le 0.50$ 0.50 $Φ \le 1.00$ 1.00 $Φ$ Total Q TY	Acceptable Q TY Accept no dense 3 2 0 3	2.5			

NO	Item	Criterion	AQL
NO 06	Glass	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	AQL
		6.2.3 Substrate protuberance and internal crack.  y: width x: length	
		$y \le 1/3L \qquad x \le a$	

NO	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
08	Backlight elements	<ul> <li>8.1 Illumination source flickers when lit.</li> <li>8.2 Spots or scratched that appear when lit must be judged. Using LCD spot, lines and contamination standards.</li> <li>8.3 Backlight doesn't light or color wrong.</li> </ul>	0.65 2.5 0.65
09	Bezel	<ul><li>9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.</li><li>9.2 Bezel must comply with job specifications.</li></ul>	2.5 0.65
10	PCB、COB	<ul> <li>10.1 COB seal may not have pinholes larger than 0.2mm or contamination.</li> <li>10.2 COB seal surface may not have pinholes through to the IC.</li> <li>10.3 The height of the COB should not exceed the height indicated in the assembly diagram.</li> <li>10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places.</li> <li>10.5 No oxidation or contamination PCB terminals.</li> <li>10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts.</li> <li>10.7 The jumper on the PCB should conform to the product characteristic chart.</li> <li>10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down.</li> </ul>	2.5 2.5 0.65 2.5 2.5 0.65 2.5
11	Soldering	<ul> <li>11.1 No un-melted solder paste may be present on the PCB.</li> <li>11.2 No cold solder joints, missing solder connections, oxidation or icicle.</li> <li>11.3 No residue or solder balls on PCB.</li> <li>11.4 No short circuits in components on PCB.</li> </ul>	2.5 2.5 2.5 0.65

NO	Item	Criterion	AQL
12	General appearance	<ul> <li>12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP.</li> <li>12.2 No cracks on interface pin (OLB) of TCP.</li> <li>12.3 No contamination, solder residue or solder balls on product.</li> <li>12.4 The IC on the TCP may not be damaged, circuits.</li> <li>12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever.</li> <li>12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color.</li> <li>12.7 Sealant on top of the ITO circuit has not hardened.</li> <li>12.8 Pin type must match type in specification sheet.</li> <li>12.9 LCD pin loose or missing pins.</li> <li>12.10 Product packaging must the same as specified on packaging specification sheet.</li> <li>12.11 Product dimension and structure must conform to product specification sheet.</li> </ul>	2.5 0.65 2.5 2.5 2.5 2.5 0.65 0.65 0.65 0.65

•	· · · · · · · · · · · · · · · · · · ·	<u>le Estima</u>	te Feedback Sheet
	Number:		Page: 1
	anel Specification:	□ <b>p</b>	
	Panel Type:	Pass	☐ NG ,
2.	View Direction:	☐ Pass	□ NG ,
3.	Numbers of Dots:	☐ Pass	□ NG ,
4.	View Area:	☐ Pass	☐ NG ,
5.	Active Area:	Pass P	□ NG ,
6.	Operating Temperature:	☐ Pass	☐ NG ,
7.	Storage Temperature:	Pass	☐ NG ,
8.	Others:		
2 · <u>N</u>	<b>Iechanical Specification</b> :		
1.	PCB Size:	Pass	□ NG ,
2.	Frame Size:	Pass	□ NG ,
3.	Material of Frame:	Pass	□ NG ,
4.	Connector Position:	Pass	□ NG ,
5.	Fix Hole Position:	Pass	□ NG ,
6.	Backlight Position:	Pass	□ NG ,
7.	Thickness of PCB:	Pass	□ NG ,
8.	Height of Frame to PCB:	Pass	□ NG ,
9.	Height of Module:	Pass	☐ NG ,
10.	Others:	Pass	☐ NG ,
3 \ <u>R</u>	telative Hole Size :		
1.	Pitch of Connector:	Pass	□ NG ,
2.	Hole size of Connector:	Pass	□ NG ,
3.	Mounting Hole size:	Pass	□ NG ,
4.	Mounting Hole Type:	Pass	□ NG ,
5.	Others:	Pass	□ NG ,
4、 <u>B</u>	acklight Specification:		
1.	B/L Type:	Pass	□ NG ,
2.	B/L Color:	Pass	□ NG ,
3.	B/L Driving Voltage (Refere	nce for LEI	
4.	B/L Driving Current:	Pass	□ NG ,
5.	Brightness of B/L:	Pass	□ NG ,
6.	B/L Solder Method:	Pass	□ NG ,
7.	Others:	Pass	□ NG ,
		>> G	o to page 2 <<



Modu	winstar lle Number :		Page: 2					
5、	<b>Electronic Characteristics of</b>	Module:						
1.	Input Voltage:	Pass	□ NG ,					
2.	Supply Current:	Pass	□ NG ,					
3.	Driving Voltage for LCD:	Pass	□ NG ,					
4.	Contrast for LCD:	Pass	□ NG ,					
5.	B/L Driving Method:	Pass	□ NG ,					
6.	Negative Voltage Output:	Pass	□ NG ,					
7.	Interface Function:	Pass	□ NG ,					
8.	LCD Uniformity:	Pass	□ NG ,					
9.	ESD test:	Pass	□ NG ,					
10.	Others:	Pass	□ NG ,					
6.	<b>Summary</b> :							
	Sales signature :							
	Customer Signature:		<b>Date</b> : / /					